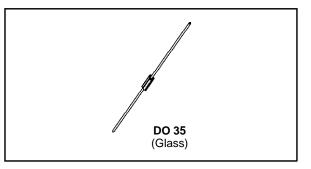


# **BAR 19**

# SMALL SIGNAL SCHOTTKY DIODE



# DESCRIPTION

Metal to silicon junction diode primarly intended for UHF mixers and ultrafast switching applications.

### **ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage		4	V
١ <sub>F</sub>	Forward Continuous Current*	T <sub>a</sub> = 25 °C	30	mA
I <sub>FSM</sub>	Surge non Repetitive Forward Current*	t <sub>p</sub> ≤ 1s	60	mA
T <sub>stg</sub> Tj	Storage and Junction Temperature Range		- 65 to +150 - 65 to +125	°C ℃
TL	Maximum Lead Temperature for Soldering during 10s at 4mm f rom Case		230	°C

## THERMAL RESISTANCE

Symbol	Test Conditions	Value	Unit
R <sub>th(j-a)</sub>	Junction-ambient*	400	°C/W

# **ELECTRICAL CHARACTERISTICS**

#### STATIC CHARACTERISTICS

Symbol	Test Conditions			Min.	Тур.	Max.	Unit
V <sub>BR</sub>	$T_{amb} = 25^{\circ}C$	$I_R = 10\mu A$		4			V
V <sub>F</sub> (1)	$T_{amb} = 25^{\circ}C$	I <sub>F</sub> = 10mA				0.6	V
I <sub>R</sub> (1)	$T_{amb} = 25^{\circ}C$	$V_R = 5V$				0.25	μA

## DYNAMIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
С	$T_{amb} = 25^{\circ}C$	$V_R = 1V$	f = 1MHz			1	pF
F (2)	$T_{amb} = 25^{\circ}C$	f = 1GHz			6		dB

\* On infinite heatsink with 4mm lead length

(1) Pulse test:  $t_p \le 300 \mu s \ \delta < 2\%$ .

(2) Noise figure test :

- diode is inserted in a tuned stripline circuit - local oscillator frequency 1GHz

- local oscillator nequency Ton

- intermediate frequency amplifier, tuned on 30MHz, has a noise figure 1.5dB

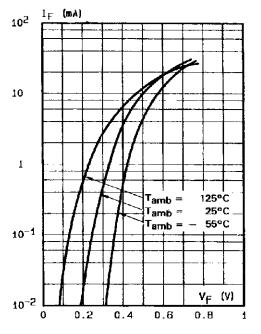


Figure 1. Forward current versus forward voltage (typical values).



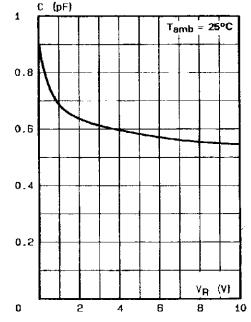


Figure 3. Reverse current versus ambient temperature.

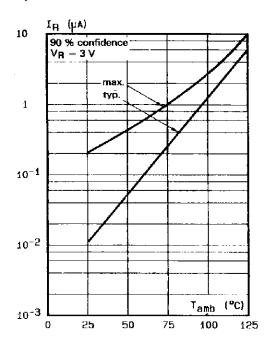
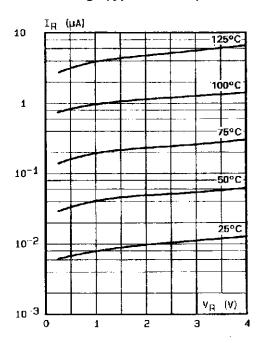
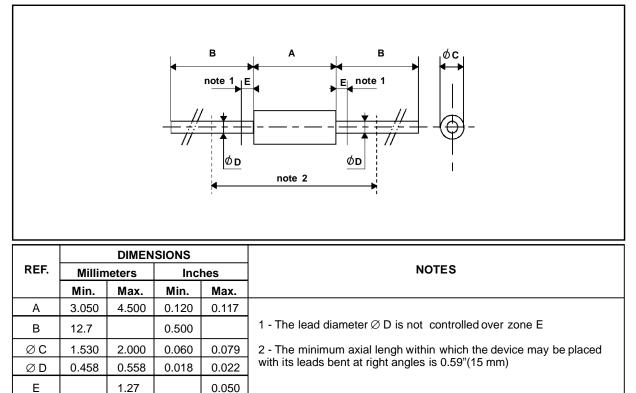


Figure 4. Reverse current versus continuous reverse voltage (typical values).



# PACKAGE MECHANICAL DATA

#### DO 35 Glass



Cooling method : by convection and conduction Marking: clear, ring at cathode end. Weight: 0.15g

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